**HB-P fibers** 

### HB-P

# Polyimide Coated Fiber for Embedded and High Temperature Applications

When your application calls for a PM fiber able to withstand temperatures above +85°C, you need Fibercore Limited's polyimide coated 'HB-P'.

HB-P can withstand temperatures as high as 400°C (300°C continuous) and is ideally suited for medical and sensing applications where the fiber must be sterilized at high temperature, or withstand the curing temperatures of even the highest performance laminates.

Polyimide is a high performance polymer widely used throughout the electronics industry. The polyimide coating is chemically bonded to the fiber's surface and is an exceptionally rugged and chemical-resistant material, offering fiber protection when applied to a thickness of just 10  $\mu$ m. In comparison, a standard acrylate coating must be applied to a thickness of 40  $\mu$ m for a 125  $\mu$ m cladding diameter fiber.

HB-P is particularly suited to embedded 'Smart-Skins' type applications due to its low-profile, which helps to maintain composite strength through a reduction in the area of the Resin Rich Zone (RRZ). In addition, the relatively thin coating, combined with the high adhesion of the glass-polyimide bond, can optimize the mechanical strain transfer in a fiber sensing system.

### 'Bow Tie' PM fiber

Fibercore's PM fibers dominate the Fiber Sensor Industry and use 'Bow-Tie' stress-applying-parts (SAPs) to create birefringence in the core. The design of these highly efficient SAPs generates exceptional levels of birefringence without excessive stress, allowing polarization orientation to be controlled effectively across a fiber system - essential for many telecoms and sensor applications.

### High Temperature, Low-Profile PM Fiber

#### **Operating Wavelengths**

830nm or 1310nm options (other wavelengths – please enquire)

### 400°C Temperature Ceiling

Polyimide coating remains stable up to 400°C. Suitable for medical sensors requiring high temperature sterilization and embedding in high-performance composites (PEEK)

#### **Ultra Low Profile**

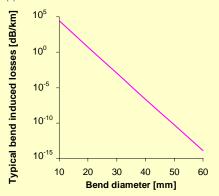
10  $\mu m,$  high-temperature polyimide coat gives a total, coated diameter of 145  $\mu m$  making HB-P ideal for embedded, 'Smart Skins' applications

# **Excellent PM Performance and Handling**

'Bow-Tie' SAPs maximize birefringence whilst minimizing internal stress within the fiber by 'focusing' stress efficiently to the core – providing optimum H-parameter with good cleave-quality and fusion-splice yields

# High Resistance to Macro and Micro-bend-induced Loss

High NA provides excellent resistance to the macro and micro-bend environments encountered in typical embedded applications



Reference

HB-P (1/2)

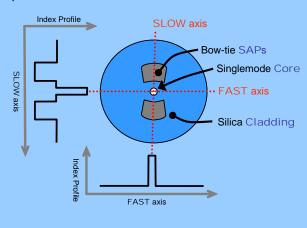


HB-P fibers

### 'Bow Tie' PM fiber

The core is flanked by areas of high-expansion, boron-doped glass that shrink-back more than the surrounding silica as the fiber is drawn and freeze the core in tension. This tension induces birefringence (ie it creates two different indices of refraction: a higher index parallel and a lower index perpendicular to the applied stress). In essence, this phenomenon is very similar to that which creates visible interference fringes when transparent plastics are stressed, except that in silica the effect is highly controlled and its magnitude is at least an order of magnitude lower than may be achieved in a plastic.

Fibercore Limited's 'Bow-Tie' design is capable of creating more birefringence than any other stressed design simply because it is based on two opposing wedges – the simplest and most efficient means of applying stress to a point.



## **Specifications**

	HB800P	HB1250P
Design wavelength $\lambda_{op}$ (nm)	830	1300
Cut-off wavelength (nm)	600-800	1030-1270
Numerical Aperture	0.14 - 0.18	
MFD @ λ <sub>op</sub> (μm) nominal	4.2	6.6
Attenuation @ $\lambda_{op}$ (dB/km)	≤ 5	≤ 2
Beat-length <sup>1</sup> (mm)	≤ 2	
Proof test (%)	1	
Fiber diameter (μm)	125 ± 1	
Core-cladding concentricity (μm)	≤ 1	
Coating type	Polyimide	
Maximum temperature (°C)	300 long term / 400 short term	
Coating diameter (µm)	140 ± 5%	

#### Notes:

### Why Polyimide?

**Extended Thermal Protection**Up to 400°C; ideal for military and medical applications

**High Solvent Resistance**Maintains fiber performance in harsh environments

Reference

HB-P (2/2)

<sup>&</sup>lt;sup>1</sup> Measured at 633 nm